

PCN Number:	20240227008.0	PCN Date:	February 27, 2024
Title:	Datasheet for TMS320F2837xD, TMS320F2837xS, and TMS320F2807x		
Customer Contact:	Change Management team	Dept:	Quality Services
Change Type:	Electrical Specification		

PCN Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



**TMS320F28379D, TMS320F28379D-Q1, TMS320F28378D, TMS320F28377D
TMS320F28377D-Q1, TMS320F28376D, TMS320F28375D, TMS320F28374D**

SPRS880P – DECEMBER 2013 – REVISED FEBRUARY 2024

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TMS320F28076, TMS320F28075, TMS320F28075-Q1
SPRS902K – OCTOBER 2014 – REVISED FEBRUARY 2024

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The datasheet number will be changing.

Device Family	Change From:	Change To:
TMS320F2837xD	SPRS880O	SPRS880P
TMS320F2837xS	SPRS881J	SPRS881K
TMS320F2807x	SPRS902J	SPRS902K

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/TMS320F28379D>

<http://www.ti.com/product/TMS320F28379S>

<http://www.ti.com/product/TMS320F28076>

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):			
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device			
Changes to product identification resulting from this PCN:			
None.			
Product Affected:			
TMS320F28374SZWTT	TMS320F28075PZPQ	TMS320F28375SZWTT	TMS320F28376SPZPS
TMS320F28376SZWTT	TMS320F28374DZWTS	TMS320F28377DZWTT	TMS320F28377DPTPT
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TMS320F28379DPTPS	TMS320F28375SZWTS	TMS320F28379SPZPT	TMS320F28377SZWTS
TMS320F28379DPTPT	TMS320F28376DPTPS	TMS320F28075PTPS	TMS320F28378SPTPS
TMS320F28379SPTPT	TMS320F28377DPTPQ	TMS320F2807NPTPT	TMS320F28379DZWTT
TMS320F28075PTPT	TMS320F28377SPTPS	TMS320F28075PTPQR	TMS320F28379SZWTT
TMS320F28374DPTPS	TMS320F28377SPZPS	TMS320F28375DZWTS	TMS320F28374SPZPS
TMS320F28374DPTPT	TMS320F28377SZWTT	TMS320F28375SPZPQ	TMS320F28374SZWTS
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TMS320F28376SPZPT	TMS320F28076PZPS	TMS320F28379SPZPS	TMS320F28374SZWTTTR
TMS320F28376SZWTS	TMS320F28374DZWTT	TMS320F28379SZWTS	TMS320F28375SPTPT
TMS320F28377DPTPS	TMS320F28375DPTPS	TMS320F28375DPTPT	TMS320F28375SPZPT
TMS320F28377SZWTTQ	TMS320F28375SPTPS	TMS320F28375DPZPS	TMS320F28378SPZPS
TMS320F28075PZPS	TMS320F28075PZPT		

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